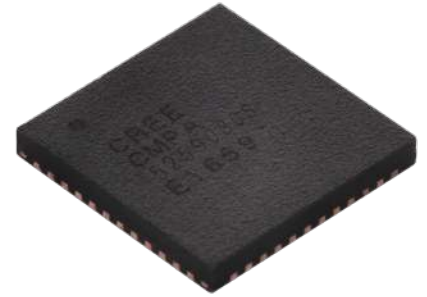


CMPA5259080S

80 W, 5.0 - 5.9 GHz, GaN MMIC, Power Amplifier

Description

Cree's CMPA5259080S is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT) based monolithic microwave integrated circuit (MMIC). GaN has superior properties compared to silicon or gallium arsenide, including higher breakdown voltage, higher saturated electron drift velocity and higher thermal conductivity. GaN HEMTs also offer greater power density and wider bandwidths compared to Si and GaAs transistors. This MMIC contains a two-stage reactively matched amplifier design approach enabling high power and power added efficiency to be achieved in a 7 mm x 7 mm surface mount (QFN package).



PN: CMPA5259080S
Package Type: 7 x 7 QFN

Typical Performance Over 5.2 - 5.9 GHz ($T_c = 25^\circ\text{C}$)

Parameter	5.2 GHz	5.5 GHz	5.9 GHz	Units
Small Signal Gain ^{1,2}	29.0	30.5	28.1	dB
Output Power ^{1,3}	112.9	112.5	99.9	W
Power Gain ^{1,3}	21.4	21.4	21.0	dB
Power Added Efficiency ^{1,3}	47	49	47	%

Notes:

¹ $V_{DD} = 40\text{ V}$, $I_{DQ} = 350\text{ mA}$

²Measured at Pin = -20 dBm

³Measured at Pin = 29 dBm and 500 μs ; Duty Cycle = 20%

Features

- >48% Typical Power Added Efficiency
- 29 dB Small Signal Gain
- 110 W Typical P_{SAT}
- Operation up to 40 V
- High Breakdown Voltage
- High Temperature Operation

Note: Features are typical performance across frequency under 25°C operation. Please reference performance charts for additional details.

Applications

- Civil and Military Pulsed Radar Amplifiers

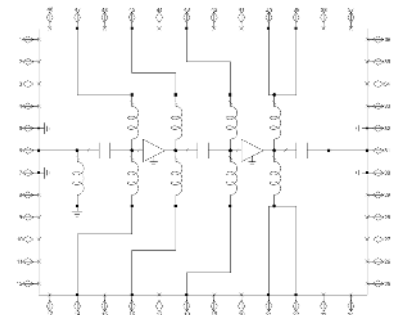


Figure 1.

RoHS
COMPLIANT

Absolute Maximum Ratings (not simultaneous) at 25°C

Parameter	Symbol	Rating	Units	Conditions
Drain-source Voltage	V_{DSS}	120	VDC	25°C
Gate-source Voltage	V_{GS}	-10, +2	VDC	25°C
Storage Temperature	T_{STG}	-55, +150	°C	
Maximum Forward Gate Current	I_G	23.2	mA	25°C
Maximum Drain Current	I_{DMAX}	4.8	A	
Soldering Temperature	T_S	260	°C	

Electrical Characteristics (Frequency = 5.2 GHz to 5.9 GHz unless otherwise stated; $T_C = 25^\circ\text{C}$)

Characteristics	Symbol	Min.	Typ.	Max.	Units	Conditions
DC Characteristics						
Gate Threshold Voltage	$V_{GS(TH)}$	-3.6	-3.1	-2.4	V	$V_{DS} = 10\text{ V}, I_D = 23.2\text{ mA}$
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V_{DC}	$V_{DD} = 40\text{ V}, I_{DQ} = 350\text{ mA}$
Saturated Drain Current ¹	I_{DS}	16.7	23.2	-	A	$V_{DS} = 6.0\text{ V}, V_{GS} = 2.0\text{ V}$
Drain-Source Breakdown Voltage	V_{BD}	100	-	-	V	$V_{GS} = -8\text{ V}, I_D = 23.2\text{ mA}$
RF Characteristics^{2,3}						
Small Signal Gain	S_{21_1}	-	27	-	dB	$P_{in} = -20\text{ dBm}, \text{Freq} = 5.2 - 5.9\text{ GHz}$
Output Power	P_{OUT1}	-	105	-	W	$V_{DD} = 40\text{ V}, I_{DQ} = 350\text{ mA}, P_{IN} = 29\text{ dBm}, \text{Freq} = 5.2\text{ GHz}$
Output Power	P_{OUT2}	-	102	-	W	$V_{DD} = 40\text{ V}, I_{DQ} = 350\text{ mA}, P_{IN} = 29\text{ dBm}, \text{Freq} = 5.5\text{ GHz}$
Output Power	P_{OUT3}	-	112	-	W	$V_{DD} = 40\text{ V}, I_{DQ} = 350\text{ mA}, P_{IN} = 29\text{ dBm}, \text{Freq} = 5.9\text{ GHz}$
Power Added Efficiency	PAE_1	-	50	-	%	$V_{DD} = 40\text{ V}, I_{DQ} = 350\text{ mA}, P_{IN} = 29\text{ dBm}, \text{Freq} = 5.2\text{ GHz}$
Power Added Efficiency	PAE_2	-	48	-	%	$V_{DD} = 40\text{ V}, I_{DQ} = 350\text{ mA}, P_{IN} = 29\text{ dBm}, \text{Freq} = 5.5\text{ GHz}$
Power Added Efficiency	PAE_3	-	48	-	%	$V_{DD} = 40\text{ V}, I_{DQ} = 350\text{ mA}, P_{IN} = 29\text{ dBm}, \text{Freq} = 5.9\text{ GHz}$
Power Gain	G_{P1}	-	21	-	dB	$V_{DD} = 40\text{ V}, I_{DQ} = 350\text{ mA}, P_{IN} = 29\text{ dBm}, \text{Freq} = 5.2\text{ GHz}$
Power Gain	G_{P2}	-	21	-	dB	$V_{DD} = 40\text{ V}, I_{DQ} = 350\text{ mA}, P_{IN} = 29\text{ dBm}, \text{Freq} = 5.5\text{ GHz}$
Power Gain	G_{P3}	-	22	-	dB	$V_{DD} = 40\text{ V}, I_{DQ} = 350\text{ mA}, P_{IN} = 29\text{ dBm}, \text{Freq} = 5.9\text{ GHz}$
Input Return Loss	S_{11}	-	-10	-	dB	$P_{in} = -20\text{ dBm}, 5.2 - 5.9\text{ GHz}$
Output Return Loss	S_{22}	-	-4	-	dB	$P_{in} = -20\text{ dBm}, 5.2 - 5.9\text{ GHz}$
Output Mismatch Stress	VSWR	-	-	3 : 1	Ψ	No damage at all phase angles

Notes:

¹ Scaled from PCM data² Measured in CMPA5259080S high volume test fixture at 5.2, 5.5 and 5.9 GHz and may not show the full capability of the device due to source inductance and thermal performance.³ Unless otherwise noted: Pulse Width = 25 μs , Duty Cycle = 1%**Thermal Characteristics**

Parameter	Symbol	Rating	Units	Conditions
Operating Junction Temperature	T_J	225	°C	
Thermal Resistance, Junction to Case (packaged) ¹	$R_{\theta JC}$	0.95	°C/W	Pulse Width = 500 μs , Duty Cycle = 20%

Notes:

¹ Simulated for the CMPA5259080S at $P_{DISS} = 120\text{ W}$



Typical Performance of the CMPA5259080S

Test conditions unless otherwise noted: $V_D = 40\text{ V}$, $I_{DQ} = 350\text{ mA}$, Pulse Width = $500\ \mu\text{s}$, Duty Cycle = 20%, Pin = 29 dBm, $T_{BASE} = +25\text{ }^\circ\text{C}$

Figure 1. Output Power vs Frequency as a Function of Temperature

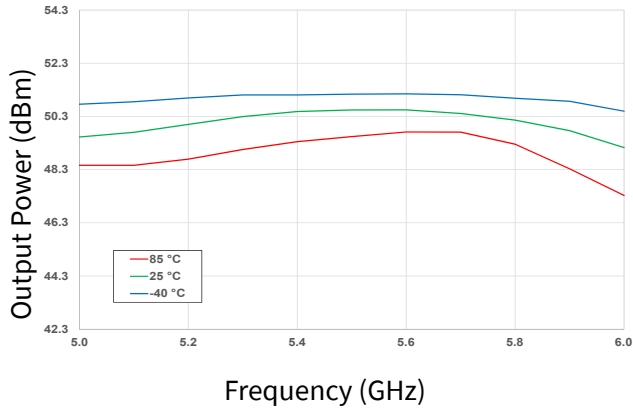


Figure 2. Output Power vs Frequency as a Function of Input Power

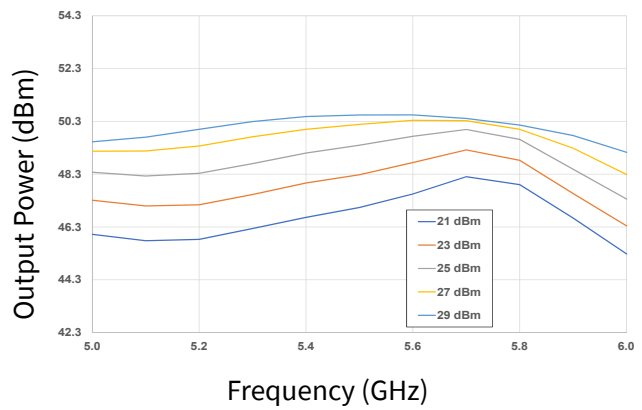


Figure 3. Power Added Eff. vs Frequency as a Function of Temperature

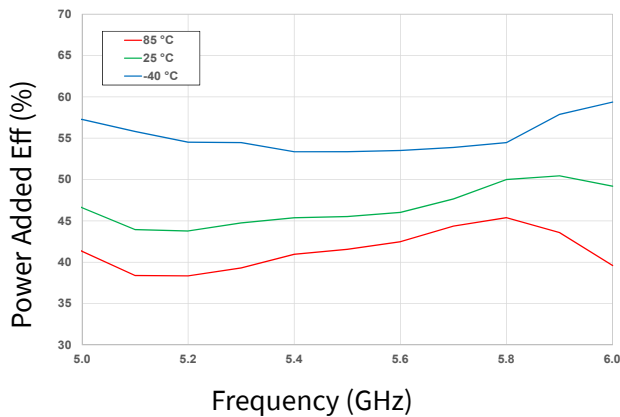


Figure 4. Power Added Eff. vs Frequency as a Function of Input Power

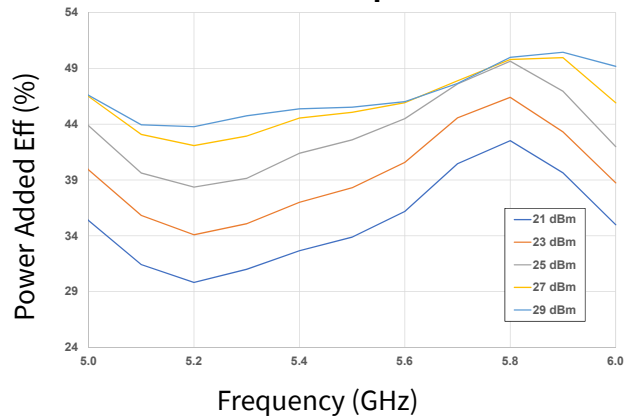


Figure 5. Drain Current vs Frequency as a Function of Temperature

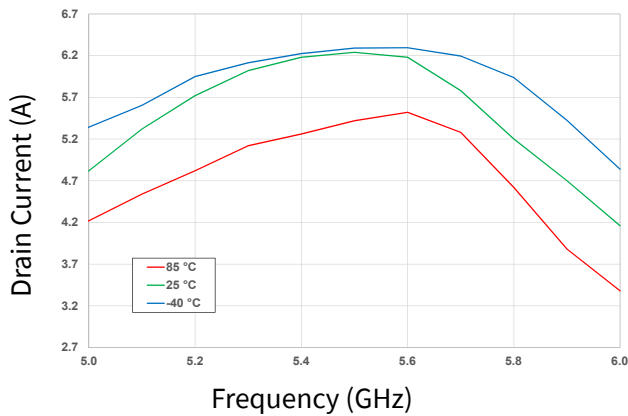
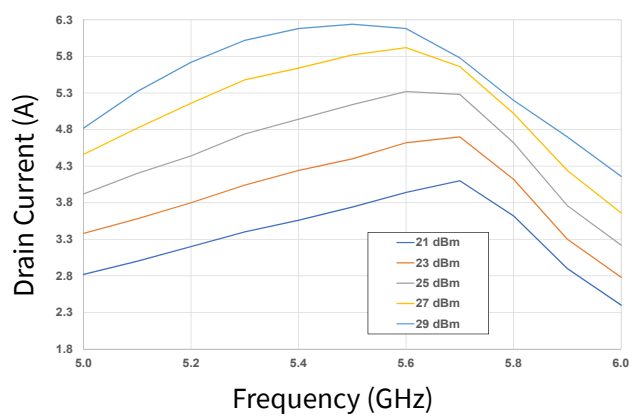


Figure 6. Drain Current vs Frequency as a Function of Input Power





Typical Performance of the CMPA5259080S

Test conditions unless otherwise noted: $V_D = 40\text{ V}$, $I_{DQ} = 350\text{ mA}$, Pulse Width = $500\text{ }\mu\text{s}$, Duty Cycle = 20%, $P_{in} = 29\text{ dBm}$, $T_{BASE} = +25\text{ }^\circ\text{C}$

Figure 7. Output Power vs Frequency as a Function of V_D

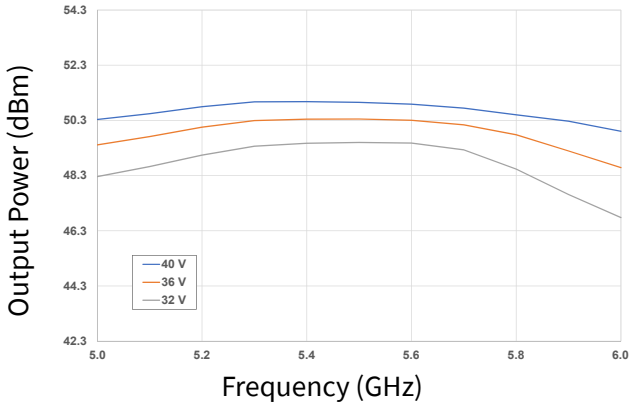


Figure 8. Output Power vs Frequency as a Function of I_{DQ}

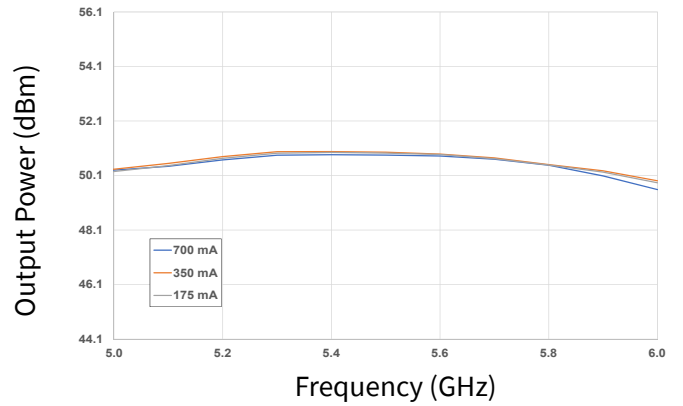


Figure 9. Power Added Eff. vs Frequency as a Function of V_D

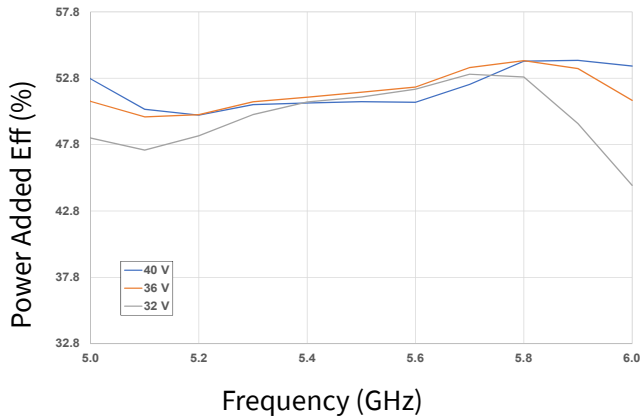


Figure 10. Power Added Eff. vs Frequency as a Function of I_{DQ}

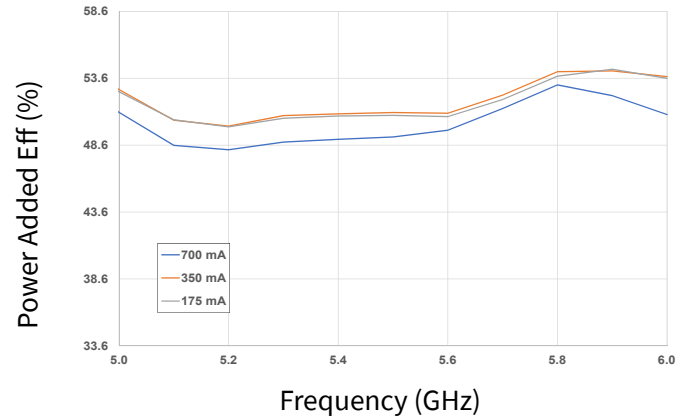


Figure 11. Drain Current vs Frequency as a Function of V_D

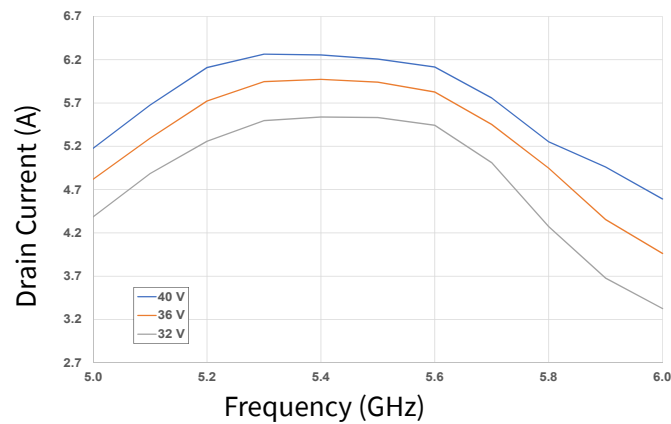
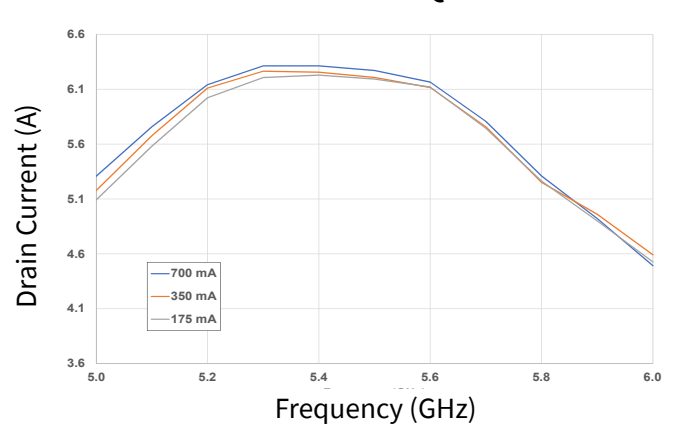


Figure 12. Drain Current vs Frequency as a Function of I_{DQ}





Typical Performance of the CMPA5259080S

Test conditions unless otherwise noted: $V_D = 40\text{ V}$, $I_{DQ} = 350\text{ mA}$, Pulse Width = $500\ \mu\text{s}$, Duty Cycle = 20%, $P_{in} = 29\text{ dBm}$, $T_{BASE} = +25\text{ }^\circ\text{C}$

Figure 13. Output Power vs Input Power as a Function of Frequency

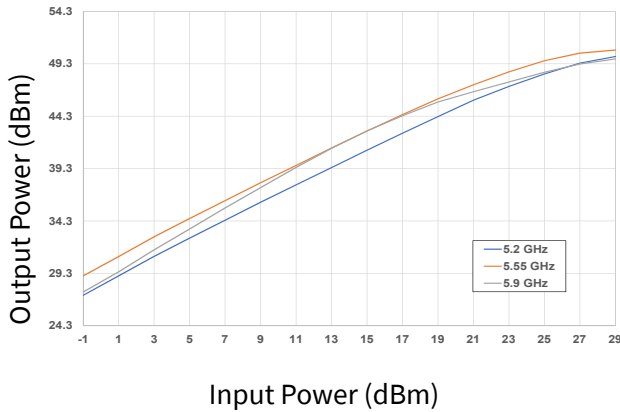


Figure 14. Power Added Eff. vs Input Power as a Function of Frequency

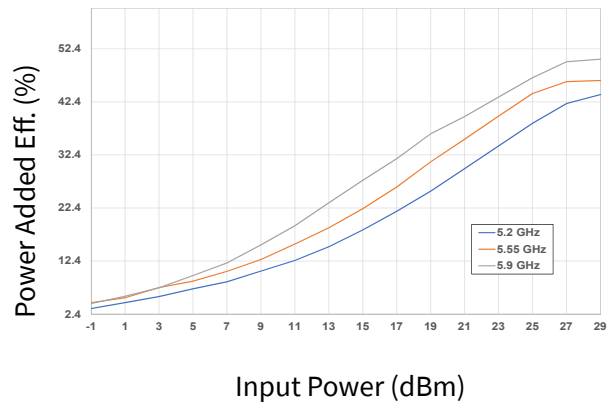


Figure 15. Large Signal Gain vs Input Power as a Function of Frequency

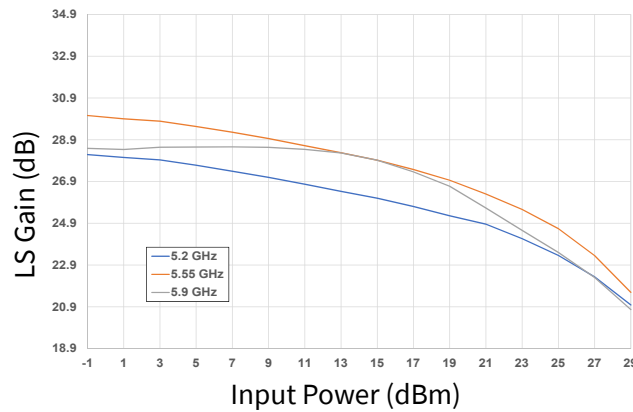


Figure 16. Drain Current vs Input Power as a Function of Frequency

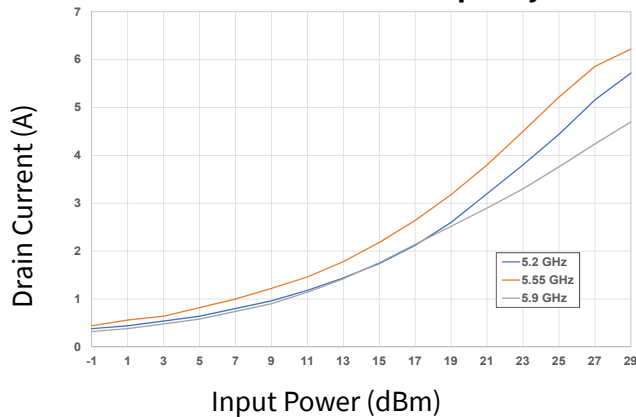
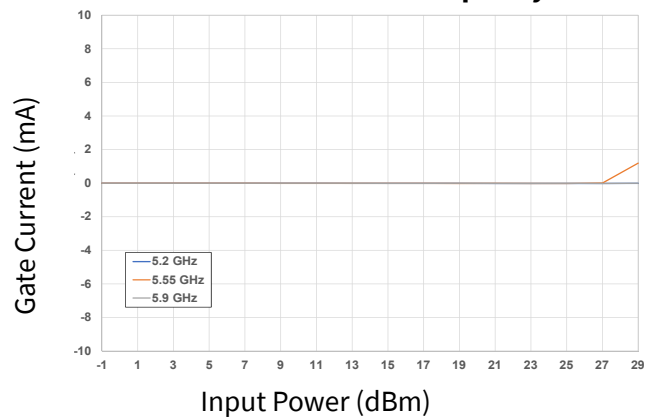


Figure 17. Gate Current vs Input Power as a Function of Frequency





Typical Performance of the CMPA5259080S

Test conditions unless otherwise noted: $V_D = 40\text{ V}$, $I_{DQ} = 350\text{ mA}$, Pulse Width = $500\ \mu\text{s}$, Duty Cycle = 20%, Pin = 29 dBm, $T_{BASE} = +25\text{ }^\circ\text{C}$

Figure 18. Output Power vs Input Power as a Function of Temperature

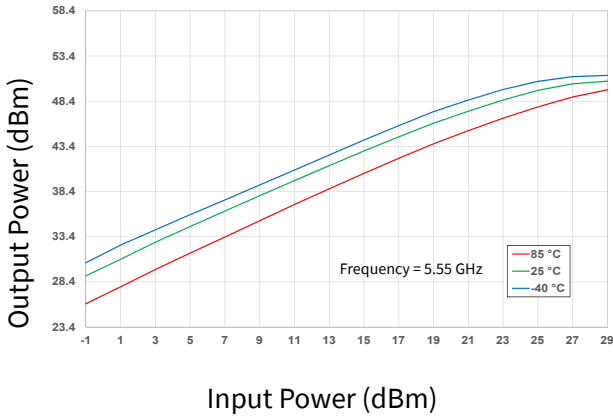


Figure 19. Power Added Eff. vs Input Power as a Function of Temperature

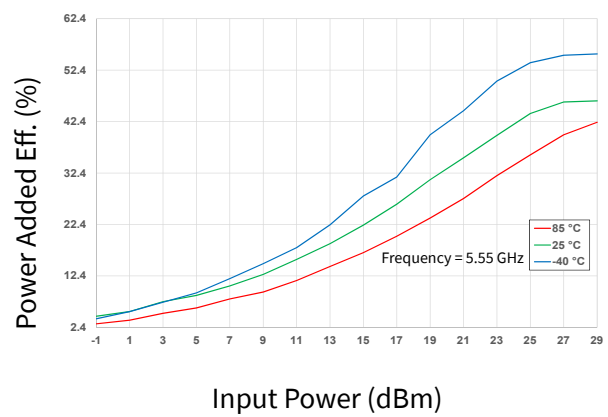


Figure 20. Large Signal Gain vs Input Power as a Function of Temperature

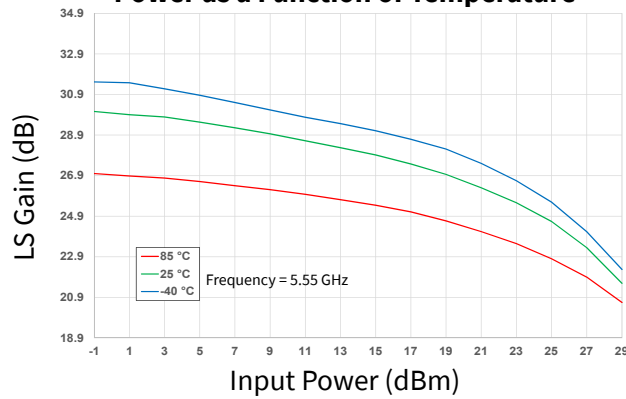


Figure 21. Drain Current vs Input Power as a Function of Temperature

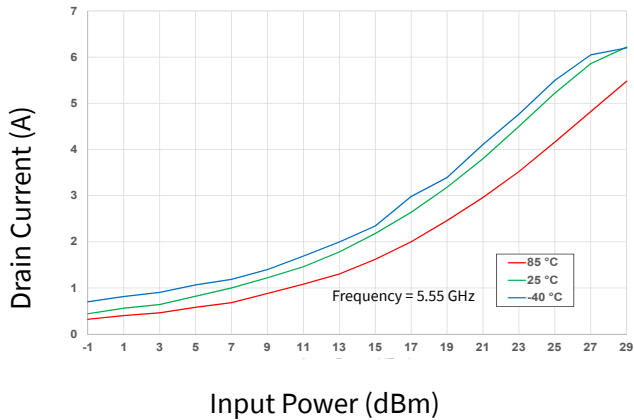
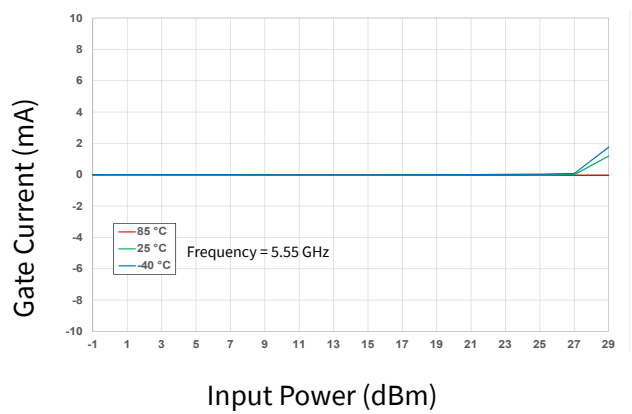


Figure 22. Gate Current vs Input Power as a Function of Temperature





Typical Performance of the CPMA5259080S

Test conditions unless otherwise noted: $V_D = 40\text{ V}$, $I_{DQ} = 350\text{ mA}$, Pulse Width = $500\ \mu\text{s}$, Duty Cycle = 20%, $P_{in} = 29\text{ dBm}$, $T_{BASE} = +25\text{ }^\circ\text{C}$

Figure 23. Output Power vs Input Power as a Function of IDQ

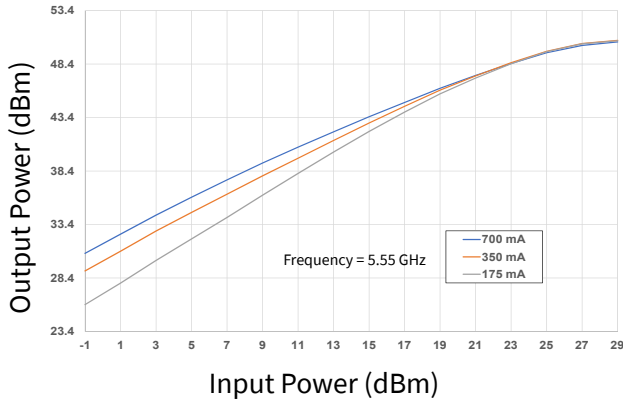


Figure 24. Power Added Eff. vs Input Power as a Function of IDQ

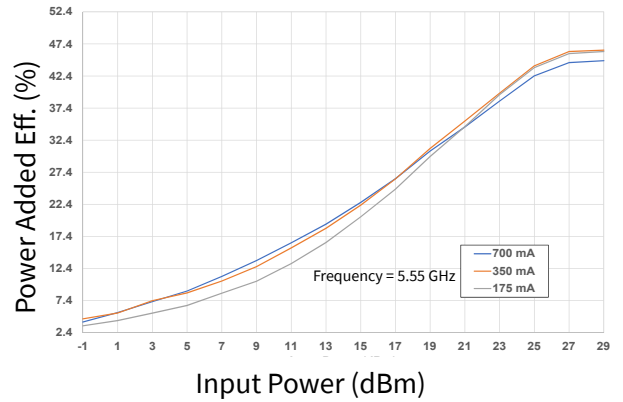


Figure 25. Large Signal Gain vs Input Power as a Function of IDQ

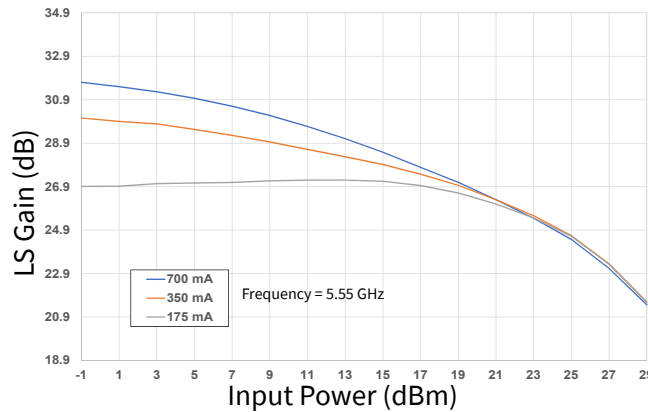


Figure 26. Drain Current vs Input Power as a Function of IDQ

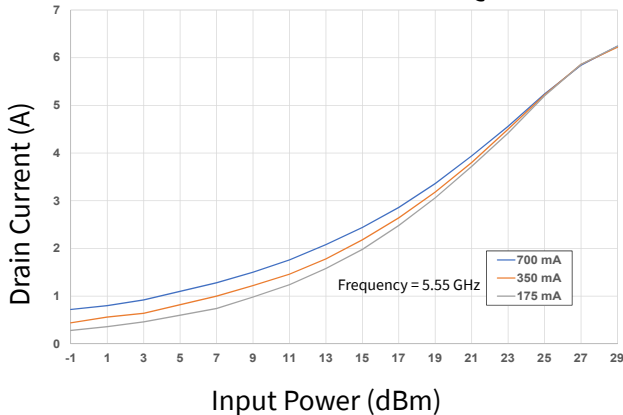
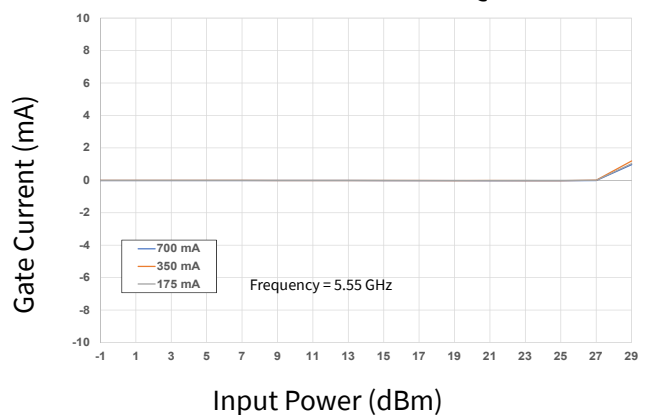


Figure 27. Gate Current vs Input Power as a Function of IDQ





Typical Performance of the CMPA5259080S

Test conditions unless otherwise noted: $V_D = 40\text{ V}$, $I_{DQ} = 350\text{ mA}$, Pulse Width = $500\text{ }\mu\text{s}$, Duty Cycle = 20%, Pin = 29 dBm, $T_{BASE} = +25\text{ }^\circ\text{C}$

Figure 28. 2nd Harmonic vs Frequency as a Function of Temperature

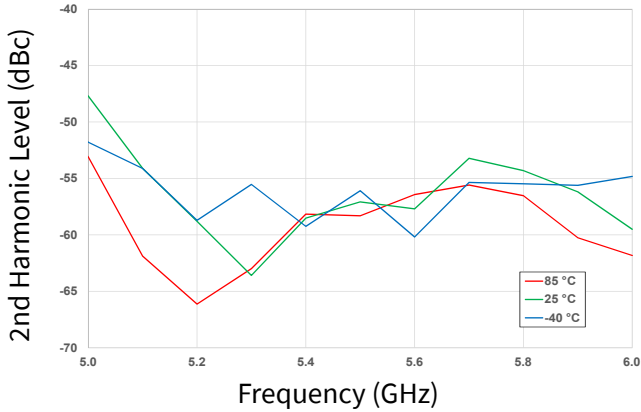


Figure 29. 3rd Harmonic vs Frequency as a Function of Temperature

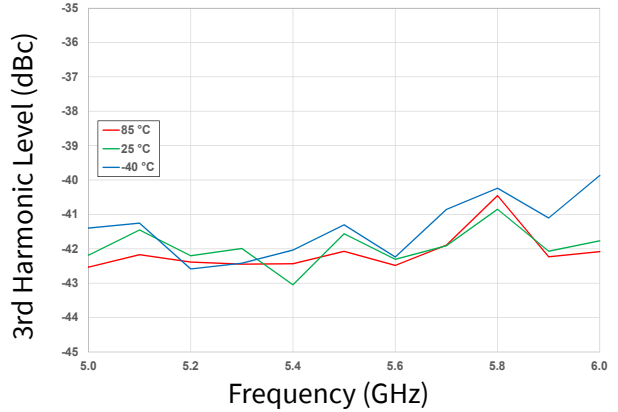


Figure 30. 2nd Harmonic vs Output Power as a Function of Frequency

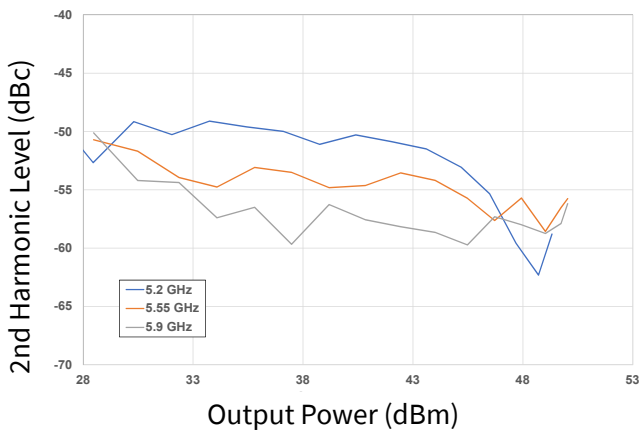


Figure 31. 3rd Harmonic vs Output Power as a Function of Frequency

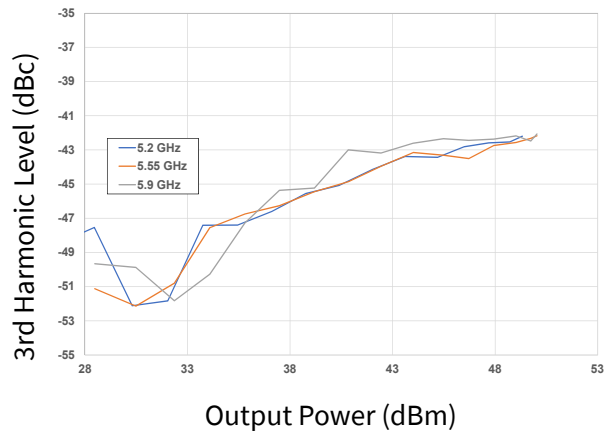


Figure 32. 2nd Harmonic vs Output Power as a Function of IDQ

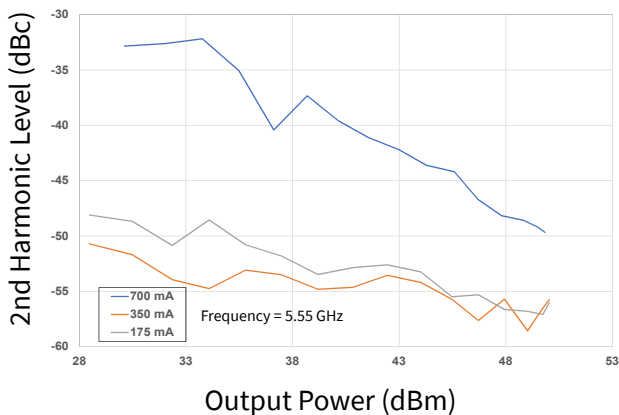
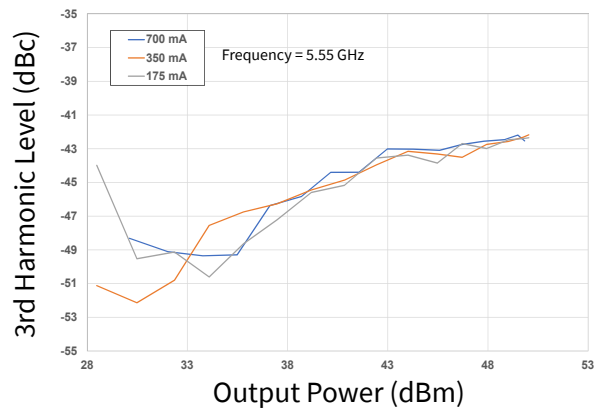


Figure 33. 3rd Harmonic vs Output Power as a Function of IDQ





Typical Performance of the CMPA5259080S

Test conditions unless otherwise noted: $V_D = 40\text{ V}$, $I_{DQ} = 350\text{ mA}$, $P_{in} = -20\text{ dBm}$, $T_{BASE} = +25\text{ }^\circ\text{C}$

Figure 34. Gain vs Frequency as a Function of Temperature

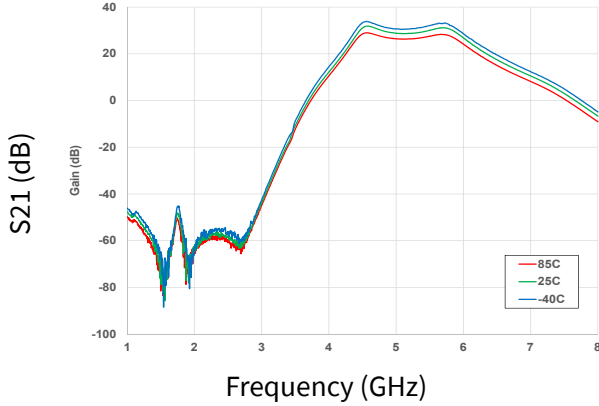


Figure 35. Gain vs Frequency as a Function of Temperature

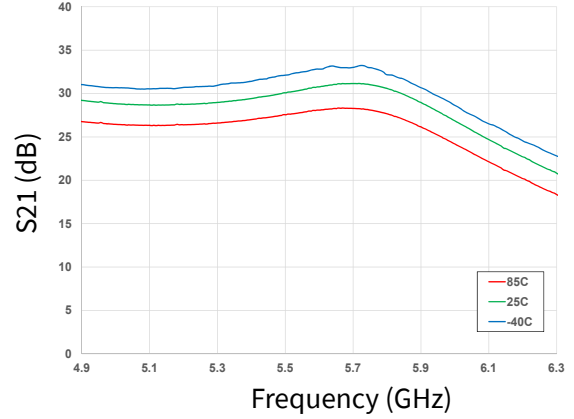


Figure 36. Input RL vs Frequency as a Function of Temperature

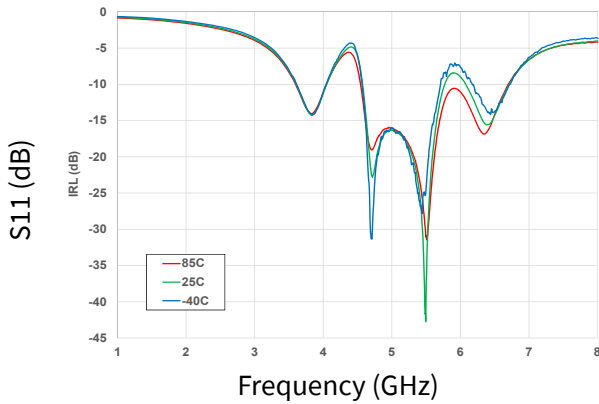


Figure 37. Input RL vs Frequency as a Function of Temperature

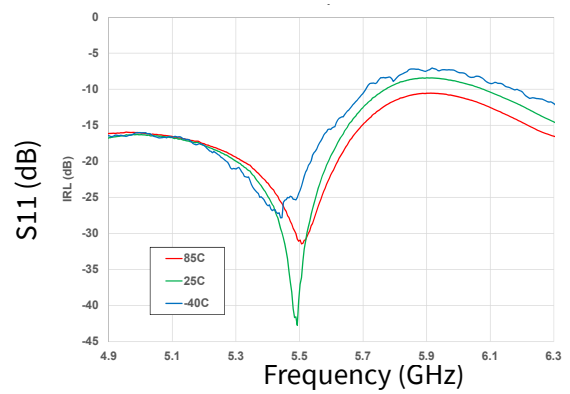


Figure 38. Output RL vs Frequency as a Function of Temperature

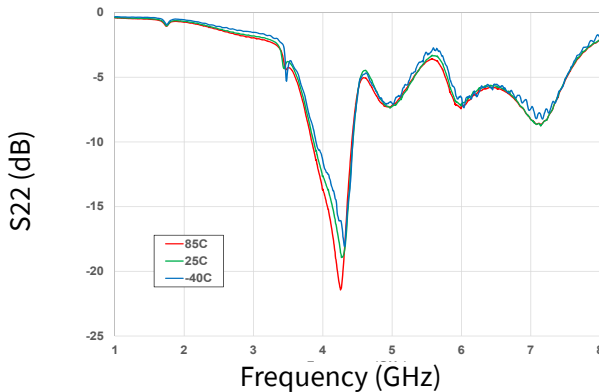
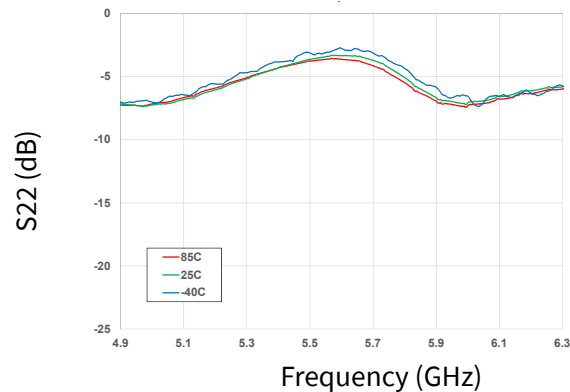


Figure 39. Output RL vs Frequency as a Function of Temperature



Typical Performance of the CMPA5259080S

Test conditions unless otherwise noted: $V_D = 40\text{ V}$, $I_{DQ} = 350\text{ mA}$, $\text{Pin} = -20\text{ dBm}$, $T_{\text{BASE}} = +25\text{ }^\circ\text{C}$

Figure 40. Gain vs Frequency as a Function of Voltage

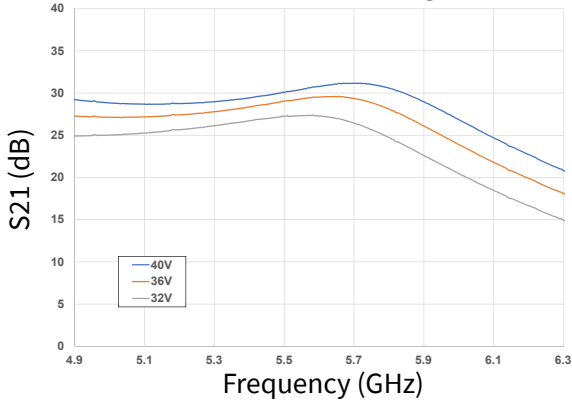


Figure 41. Gain vs Frequency as a Function of IDQ

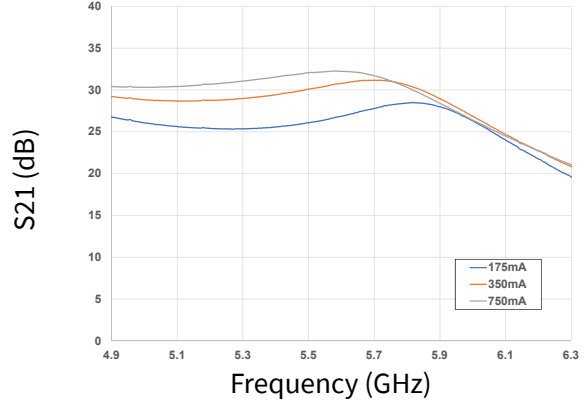


Figure 42. Input RL vs Frequency as a Function Voltage

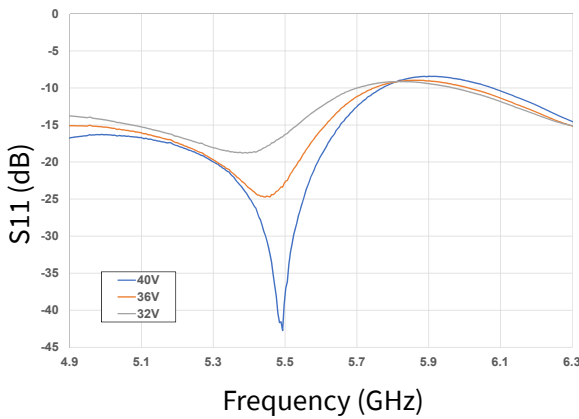


Figure 43. Input RL vs Frequency as a Function of IDQ

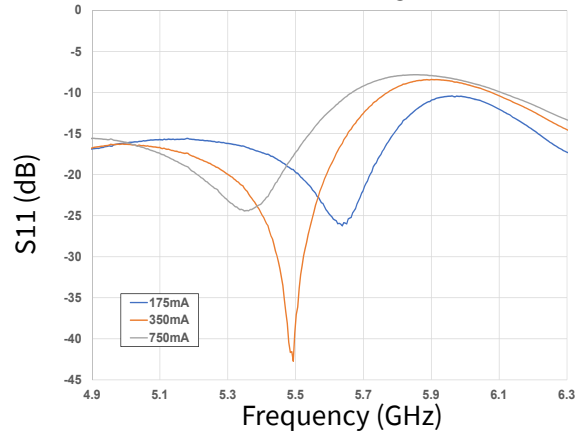


Figure 44. Output RL vs Frequency as a Function of Voltage

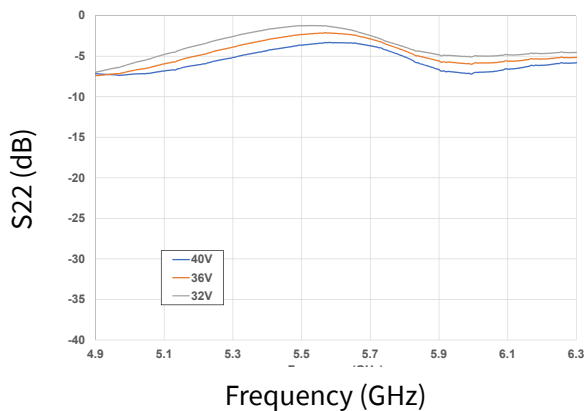
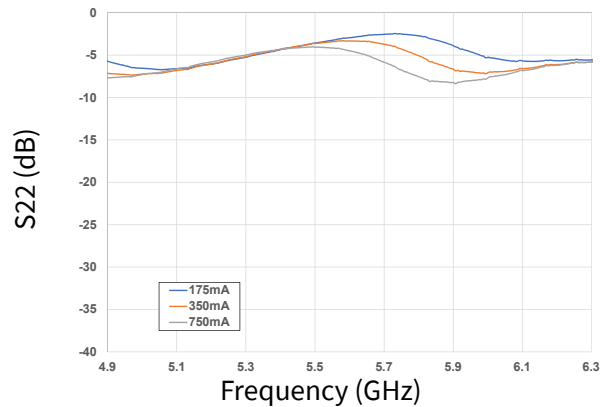
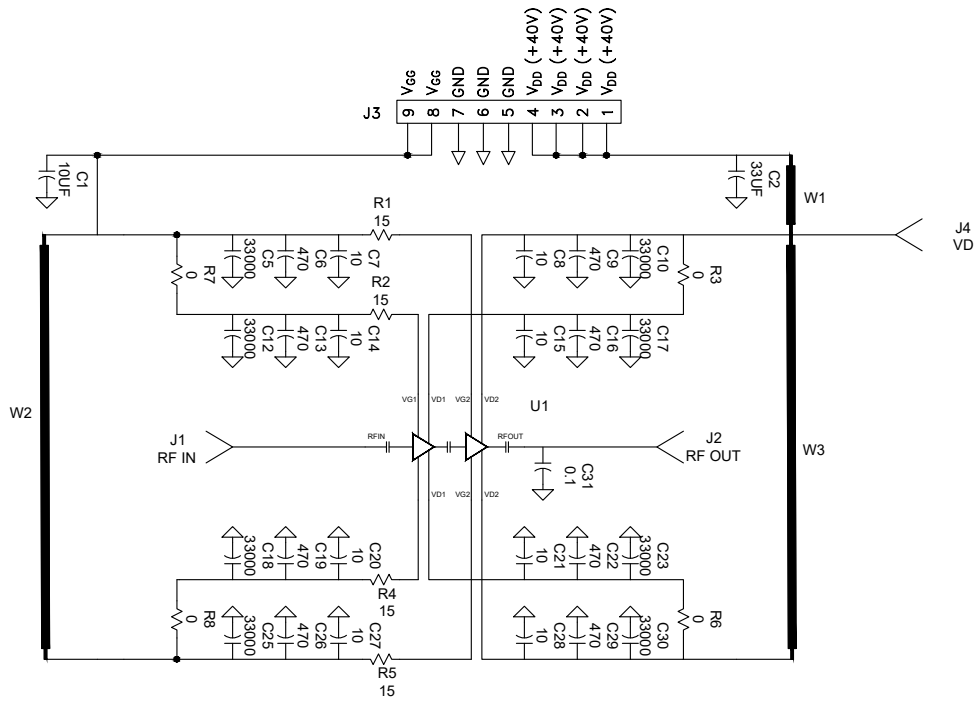


Figure 45. Output RL vs Frequency as a Function of IDQ

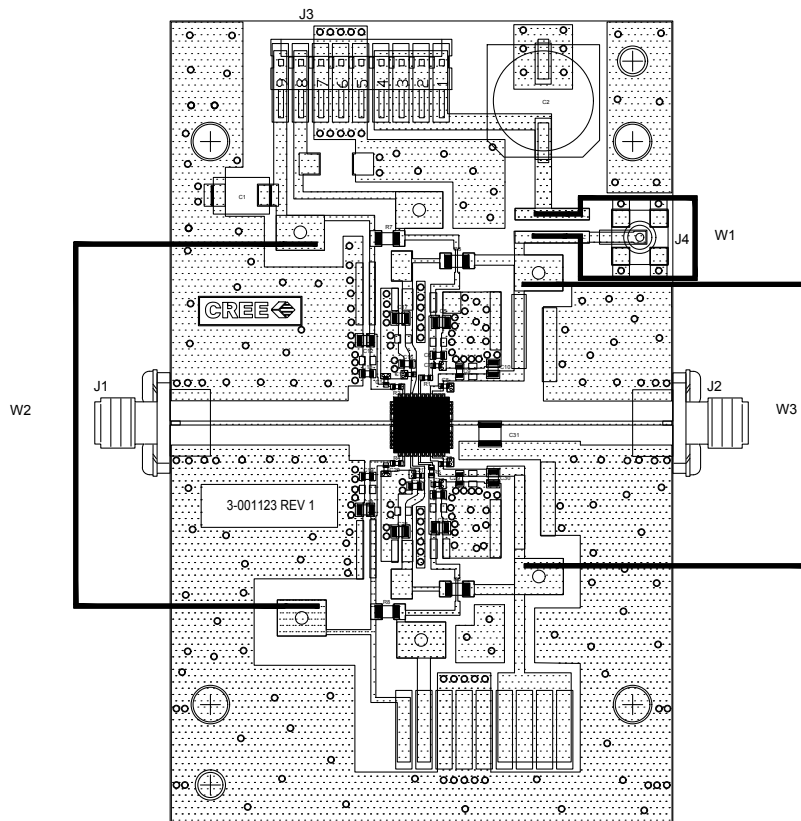




CMPA5259080S-AMP1 Demonstration Amplifier Schematic



CMPA5259080S-AMP1 Demonstration Amplifier Circuit Outline



CMPA5259080S-AMP1 Demonstration Amplifier Circuit Bill of Materials

Designator	Description	Qty
C7, C8, C14, C15, C20, C21, C27, C28	CAP, 10pF, +/-5%,pF,200V, 0402	8
C6, C9, C13, C16, C29, C22, C26, C29	CAP, 470PF, 5%, 100V, 0603, X	8
C5, C10, C12, C17, C18, C23, C25, C30	CAP,33000PF, 0805,100V, X7R	8
C2	CAP, 33 UF, 20%, G CASE	1
C1	CAP, 10UF, 16V, TANTALUM	1
C31	CAP, 0.1PF, ATC 100 B	1
R1,R2,R4,R5	RES 15 OHM, +/-1%, 1/16W, 0402	4
R3,R6,R7,R8	RES 0.0 OHM 1/16W 0402 SMD	2
J1,J2	CONN, SMA, PANEL MOUNT JACK, FLANGE, 4-HOLE, BLUNT POST, 20MIL	2
J4	CONN, SMB, STRAIGHT JACK RECEPTACLE, SMT, 50 OHM, Au PLATED	1
J3	HEADER RT>PLZ .1CEN LK 9POS	1
W2,W3	WIRE, BLACK, 22 AWG ~ 2.5"	2
W1	WIRE, BLACK, 22 AWG ~ 3.0"	1
	PCB, TEST FIXTURE, RF-35TC, 0.010 THK, 7x7 AIR CAVITY QFN, EVAL BOARD	1
	2-56 SOC HD SCREW 3/16 SS	4
	#2 SPLIT LOCKWASHER SS	4
U1	CMPA5259080S	1

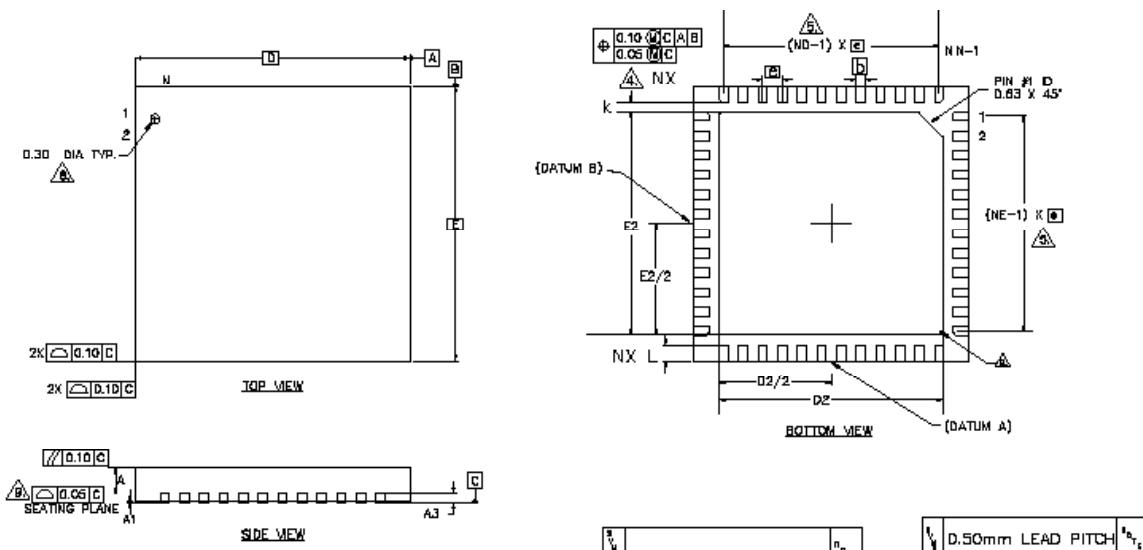
Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Test Methodology
Human Body Model	HBM	1B (≥ 500 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	II (≥ 200 V)	JEDEC JESD22 C101-C

Moisture Sensitivity Level (MSL) Classification

Parameter	Symbol	Level	Test Methodology
Moisture Sensitivity Level	MSL	3 (168 hours)	IPC/JEDEC J-STD-20

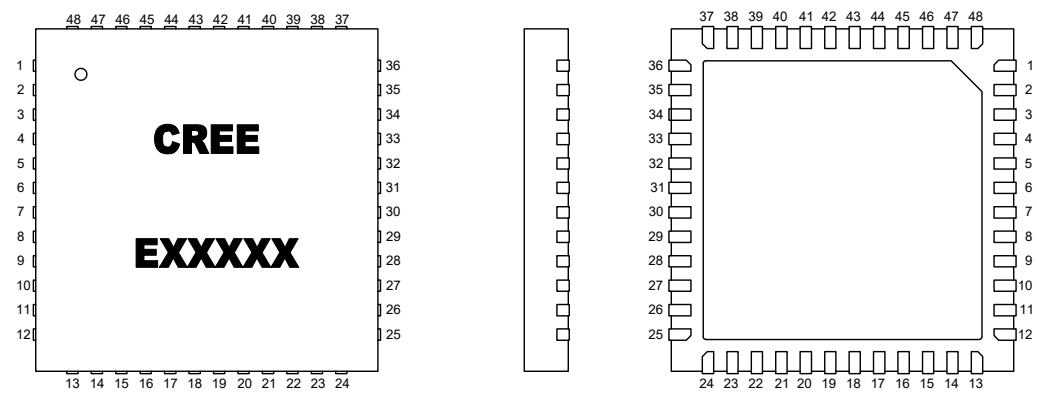
Product Dimensions CMPA5259080S (Package 7 x 7 QFN)



- NOTES :**
1. DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5M - 1994.
 2. ALL DIMENSIONS ARE IN MILLIMETERS, θ IS IN DEGREES.
 3. N IS THE TOTAL NUMBER OF TERMINALS.
 4. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN D.15 AND 0.30mm FROM TERMINAL TP.
 5. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
 6. MAX. PACKAGE WARPAGE IS 0.03 mm.
 7. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
 8. PIN #1 ID ON TOP WILL BE LASER MARKED.
 9. BILATERAL COPLANARITY ZONE APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
 10. THIS DRAWING CONFORMS TO JEDEC REGISTERED OUTLINE MO-220
 11. ALL PLATED SURFACES ARE TIN 0.010 mm +/- 0.005mm.

SYMBOL	MIN.	NOM.	MAX.	UNIT
A	0.80	0.9	1.0	
A1	0.00	0.03	0.08	
A3	0.20 REF.			
C	0	12	2	
K	0.20 MIN.			
D	7.0 BSC			
E	7.0 BSC			

SYMBOL	D.50mm LEAD PITCH			UNIT
	MIN.	NOM.	MAX.	
b	0.50 BSC.			
N	48			
ND	12			
NE	12			
L	0.36	0.41	0.48	
b	0.19	0.25	0.33	
D2	5.61	5.72	5.83	
E2	5.61	5.72	5.83	



PIN	DESC.	PIN	DESC.	PIN	DESC.	PIN	DESC.
1	NC	15	NC	29	NC	43	VG2B
2	NC	16	VD1A	30	RFGND	44	NC
3	NC	17	NC	31	RFOUT	45	VD1B
4	NC	18	VG2A	32	RFGND	46	NC
5	RFGND	19	NC	33	NC	47	VG1B
6	RFIN	20	NC	34	NC	48	NC
7	RFGND	21	VD2A	35	NC		
8	NC	22	VD2A	36	NC		
9	NC	23	NC	37	NC		
10	NC	24	NC	38	NC		
11	NC	25	NC	39	VD2B		
12	NC	26	NC	40	VD2B		
13	NC	27	NC	41	NC		
14	VG1A	28	NC	42	NC		

Part Number System

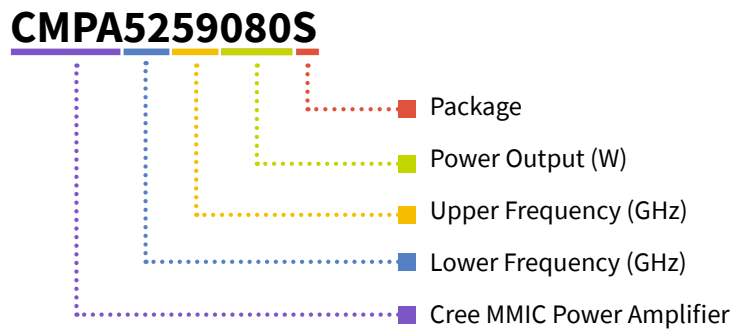


Table 1.

Parameter	Value	Units
Lower Frequency	5.2	GHz
Upper Frequency	5.9	GHz
Power Output	80	W
Package	Surface Mount	-

Note¹: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Table 2.

Character Code	Code Value
A	0
B	1
C	2
D	3
E	4
F	5
G	6
H	7
J	8
K	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz



Product Ordering Information

Order Number	Description	Unit of Measure	Image
CMPA5259080S	GaN HEMT	Each	
CMPA5259080S-AMP1	Test board with GaN MMIC installed	Each	



For more information, please contact:

4600 Silicon Drive
Durham, North Carolina, USA 27703
www.wolfspeed.com/rf

Sales Contact
rfsales@cree.com

Notes & Disclaimer

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